onsemi

<u>MOSFET</u> – Power, Single N-Channel, μ8FL 30 V, 3.6 mΩ, 102 A

NVTFS4C05N

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- NVTFS4C05NWF Wettable Flanks Product
- NVT Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

WANIMOW RATINGS (1) = 25°C unless otherwise stated)					
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain Current $R_{\theta JA}$		$T_A = 25^{\circ}C$	Ι _D	22	A
(Notes 1, 2, 4)		$T_A = 100^{\circ}C$		15.7	
Power Dissipation $R_{\theta JA}$		T _A = 25°C	PD	3.2	W
(Notes 1, 2, 4)	Steady	$T_A = 100^{\circ}C$		1.6	
Continuous Drain Current $R_{\psi JC}$	State	$T_{C} = 25^{\circ}C$	Ι _D	102	A
(Notes 1, 3, 4)		$T_{C} = 100^{\circ}C$		72	
Power Dissipation		$T_C = 25^{\circ}C$	PD	68	W
$R_{\psi JC}$ (Notes 1, 3, 4)		$T_{C} = 100^{\circ}C$		34	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \ \mu s$		I _{DM}	433	А
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode)			۱ _S	65	А
Single Pulse Drain–to–Source Avalanche Energy (T _J = 25°C, V _{GS} = 10 V, I _L = 18.8 A, L = 0.5 mH)			E _{AS}	88	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Notes 1, 3)	$R_{\psi JC}$	2.2	°C/W
Junction-to-Ambient – Steady State (Notes 1, 2)	R_{\thetaJA}	47	

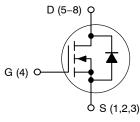
 The entire application environment impacts the thermal resistance values shown; they are not constants and are valid for the specific conditions noted.
 Surface-mounted on FR4 board using 650 mm², 2 oz. Cu Pad.

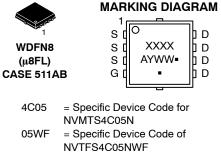
 3. Assumes heat-sink sufficiently large to maintain constant case temperature independent of device power.

 Continuous DC current rating. Maximum current for pulses as long as one second is higher but dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX	
30 V	3.6 mΩ @ 10 V	102 A	
30 V	5.1 mΩ @ 4.5 V	102 A	

N-Channel MOSFET





	INVIES4CUSINVE	
A	= Assembly Location	
Y	= Year	
۱۸/۱۸/	- Work Week	

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	= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

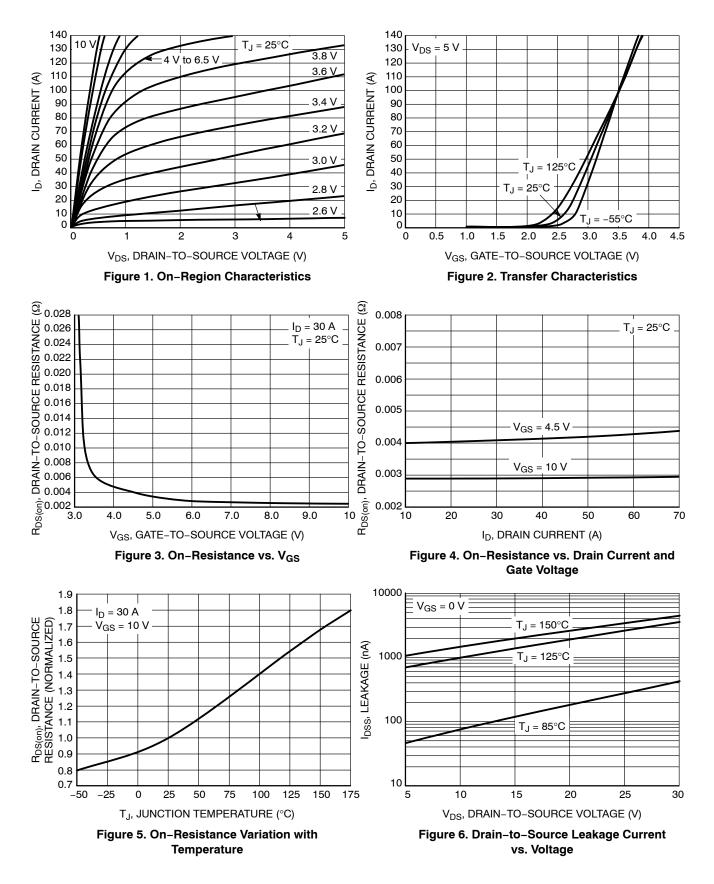
See detailed ordering, marking and shipping information on page 5 of this data sheet.

# ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified) Parameter Symbol Test Co

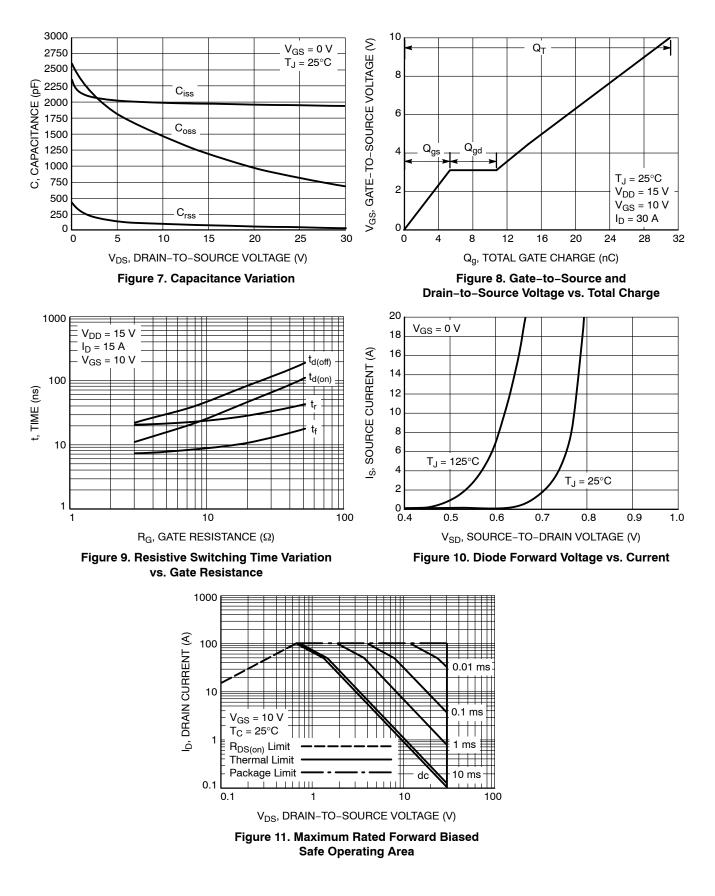
Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
OFF CHARACTERISTICS					-	-	
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D$	= 250 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				11.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25°C T _J = 125°C			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	5			±100	nA
ON CHARACTERISTICS (Note 5)	400		0				
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I _D	= 250 μA	1.3		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J		L. L.		-5.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		2.9	3.6	
	20(0)	V _{GS} = 4.5 V	I _D = 30 A		4.1	5.1	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 1.5 V,	I _D = 15 A		68		S
Gate Resistance	R _G	T _A = 25			1.0		Ω
CHARGES AND CAPACITANCES							<u> </u>
Input Capacitance	C _{ISS}				1988		
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MI	Hz, V _{DS} = 15 V		1224		pF
Reverse Transfer Capacitance	C _{RSS}				71		
Capacitance Ratio	C _{RSS} /C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz			0.036		
Total Gate Charge	Q _{G(TOT)}				14.5		
Threshold Gate Charge	Q _{G(TH)}				2.9		
Gate-to-Source Charge	Q _{GS}	$V_{GS}$ = 4.5 V, $V_{DS}$ = 15 V; $I_D$ = 30 A $V_{GS}$ = 10 V, $V_{DS}$ = 15 V; $I_D$ = 30 A			5.2		nC
Gate-to-Drain Charge	Q _{GD}				5.5		
Gate Plateau Voltage	V _{GP}				3.1		V
Total Gate Charge	Q _{G(TOT)}				31		nC
SWITCHING CHARACTERISTICS (Note	6)				-	-	
Turn-On Delay Time	t _{d(ON)}				11		
Rise Time	tr	V _{GS} = 4.5 V, V _I			30		ns
Turn-Off Delay Time	t _{d(OFF)}	V _{GS} = 4.5 V, V _I I _D = 15 A, R _G	a = 3.0 Ω		20		
Fall Time	t _f				8.0		
Turn-On Delay Time	t _{d(ON)}	$V_{GS}$ = 10 V, $V_{DS}$ = 15 V, $I_{D}$ = 15 A, $R_{G}$ = 3.0 $\Omega$			8.0		
Rise Time	t _r				25		1
Turn-Off Delay Time	t _{d(OFF)}				26		ns
Fall Time	t _f				5.0		
DRAIN-SOURCE DIODE CHARACTER	STICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.77	1.1	v
		I _S = 10 A	T _J = 125°C		0.62		v
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 30 A			42.4		
Charge Time	t _a				21.1		ns
Discharge Time	t _b				21.3		
Reverse Recovery Charge	Q _{RR}				34.4		nC

 $\begin{array}{ll} \text{5. Pulse Test: pulse width} \leq 300 \ \mu\text{s} \text{, duty cycle} \leq 2\%. \\ \text{6. Switching characteristics are independent of operating junction temperatures.} \end{array}$ 

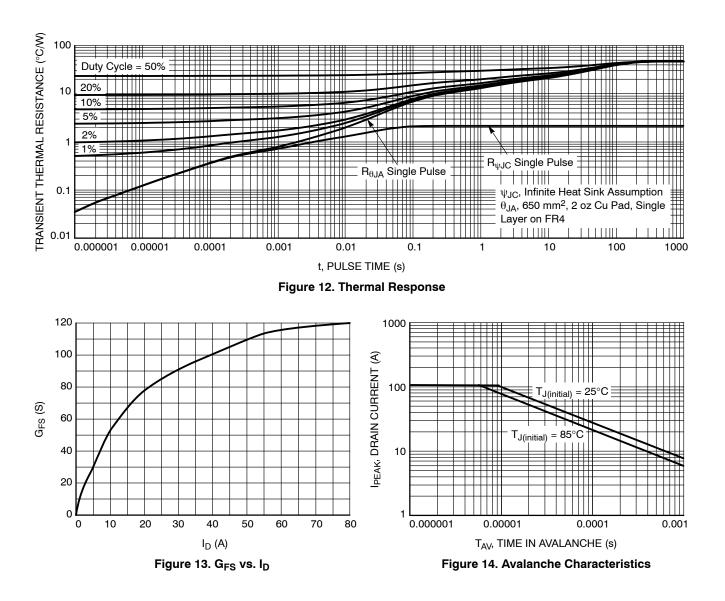
### **TYPICAL CHARACTERISTICS**



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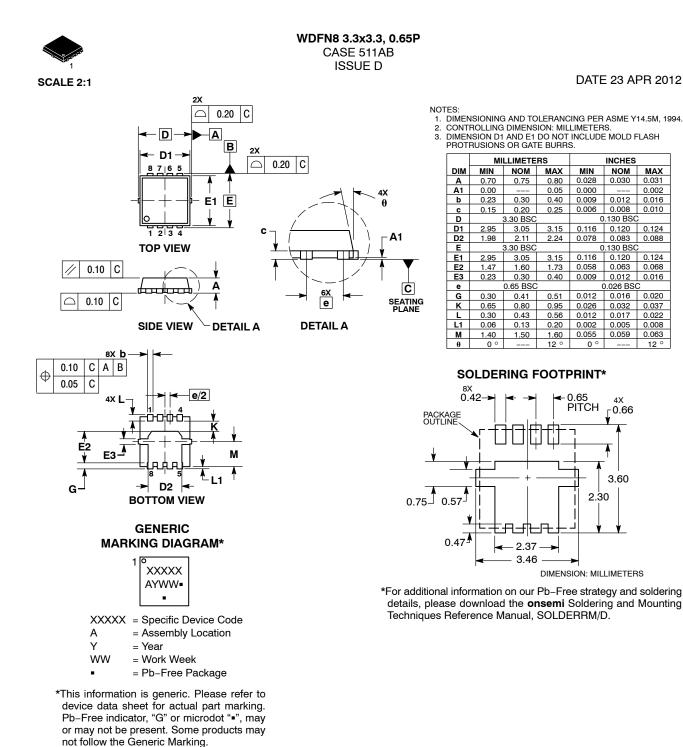


#### **ORDERING INFORMATION**

Device	Package	Shipping [†]
NVTFS4C05NTAG	WDFN8 (Pb-Free)	1500 / Tape & Reel
NVTFS4C305NETAG-YE	WDFN8 (Pb-Free)	1500 / Tape & Reel
NVTFS4C05NWFTAG	WDFN8 (Pb-Free)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





 
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